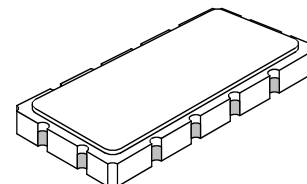


SF2257A

**70 MHz
SAW Filter**



SM13365-12

- **Precision IF SAW Filter**
- **Hermetic 13.3 x 6.5 mm Surface-mount Case**
- **Complies with Directive 2002/95/EC (RoHS)**
- **Moisture Sensitivity Level: 1**

Absolute Maximum Ratings

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage on any Non-ground Terminal	10	VDC
Storage Temperature Range of Component	-55 to +95	°C
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max	Units
Center Frequency	f_C		69.9	70.0	70.1	MHz
1 dB Bandwidth	BW_1		0.80	0.92		
3 dB Bandwidth	BW_3		1.1	1.2		
40 dB Bandwidth	BW_{40}			2.2	2.3	
Insertion Loss	IL			10.5	11.5	dB
Amplitude Ripple, $f_C \pm 0.3$ MHz				0.7	1.0	dB _{p-p}
Group Delay Ripple, $f_C \pm 0.3$ MHz				350	400	ns _{p-p}
Relative Attenuation:						dB
DC to 65 MHz			45	55		
75 to 200 MHz			45	55		
Operating Temperature Range			-55		+95	°C

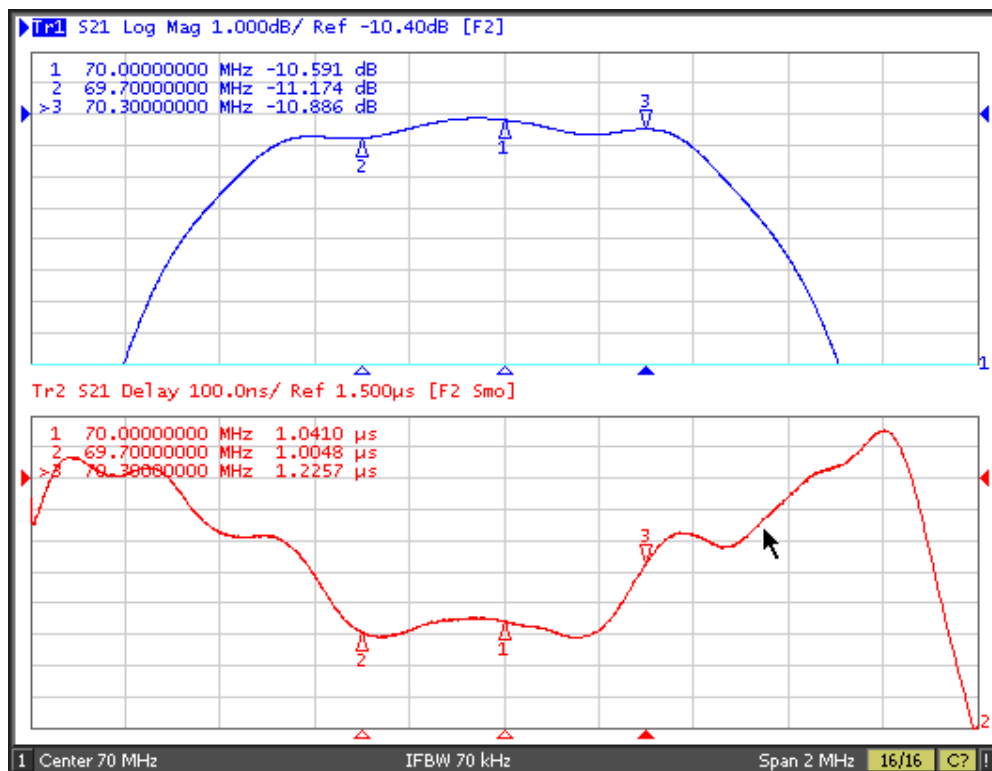
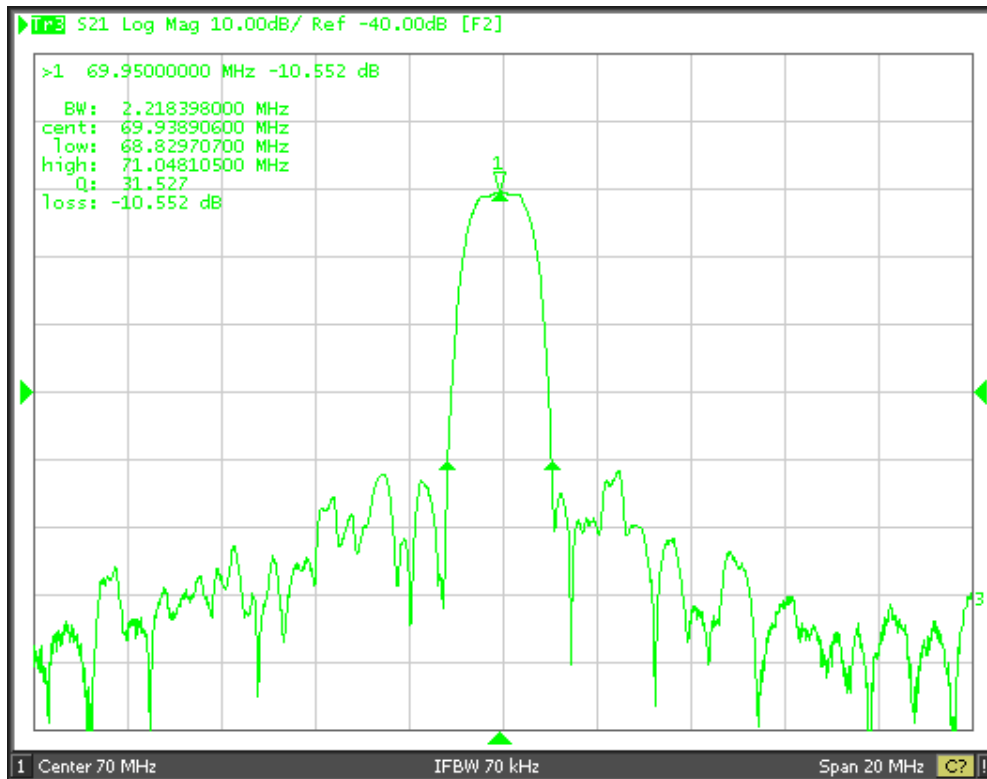
Impedance Matching to 50 Ω Unbalanced Source/Load	External L-C
Case Style	13.3 x 6.5 mm Nominal Footprint

 **CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.**

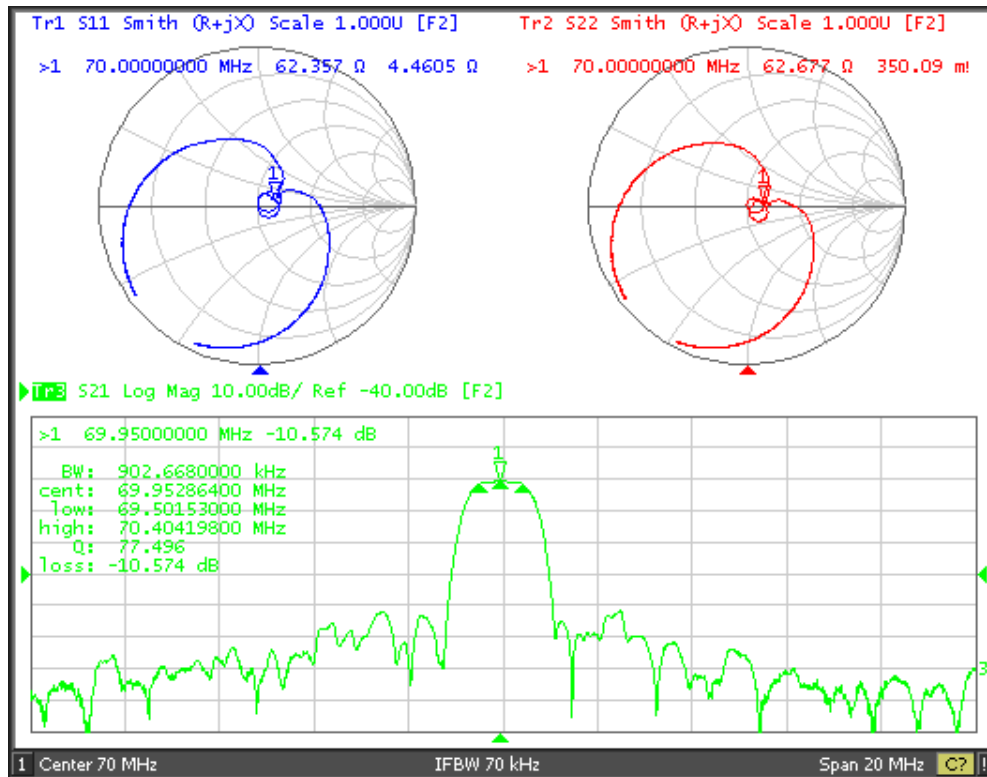
NOTES:

1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.
3. RoHS compliant from the first date of manufacture.

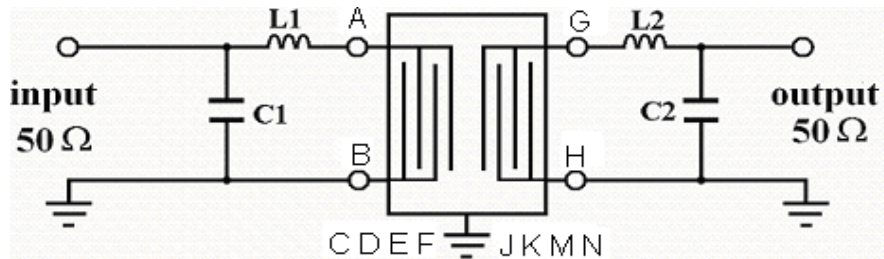
Filter Response Plots



Filter Impedance Plots

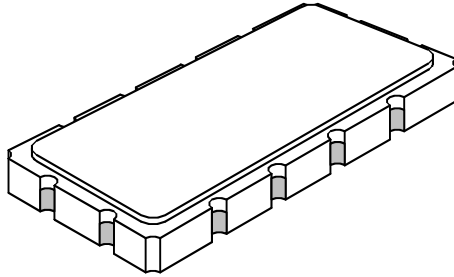


Typical Tuning Component Values



$C1 = 82 \text{ pF}$, $L1 = 27 + 470 \text{ nH}$, $L2 = 470 + 68 \text{ nH}$, $C2 = 82 \text{ pF}$

Ceramic Surface-mount 12-Terminal Case 13.3 x 6.5 mm Nominal Footprint



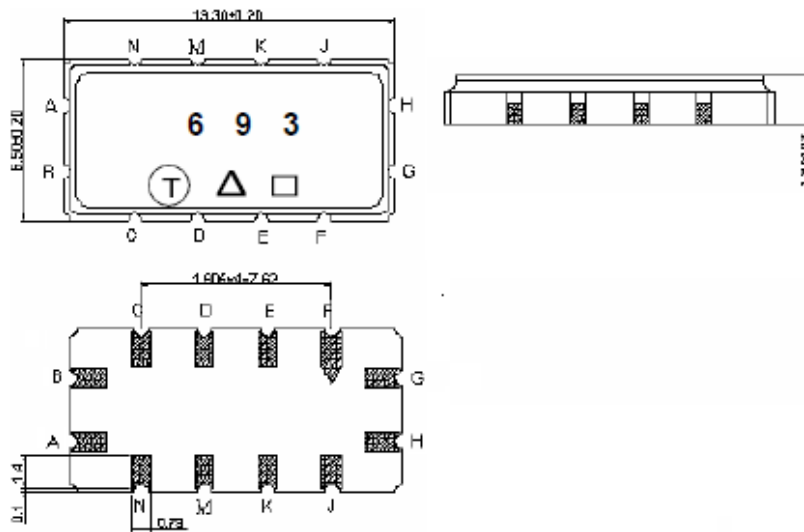
Case Material

Materials	
Solder Pad Plating	0.3 to 1.0 μm Gold over 1.27 to 8.89 μm Nickel
Lid Plating	2.0 to 3.0 μm Nickel
Body	Al_2O_3 Ceramic

Electrical Connections

Connection	Terminals
Input	A
Output	G
Case Ground	All others

Case Outline Drawing



Pin A –RF input

Pin B –RF input ground

Pin G –RF output

Pin H –RF output ground

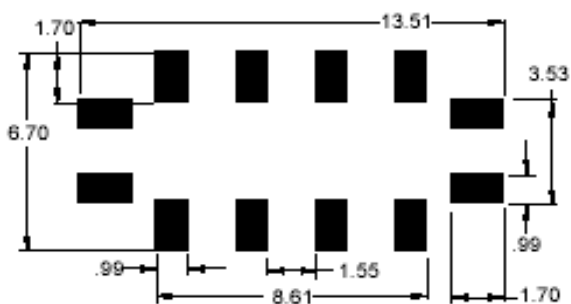
Pin C, D, E, F, J, K, M, N - Ground

□ : Week Code (Follow the table from planner each year)

Unit : mm

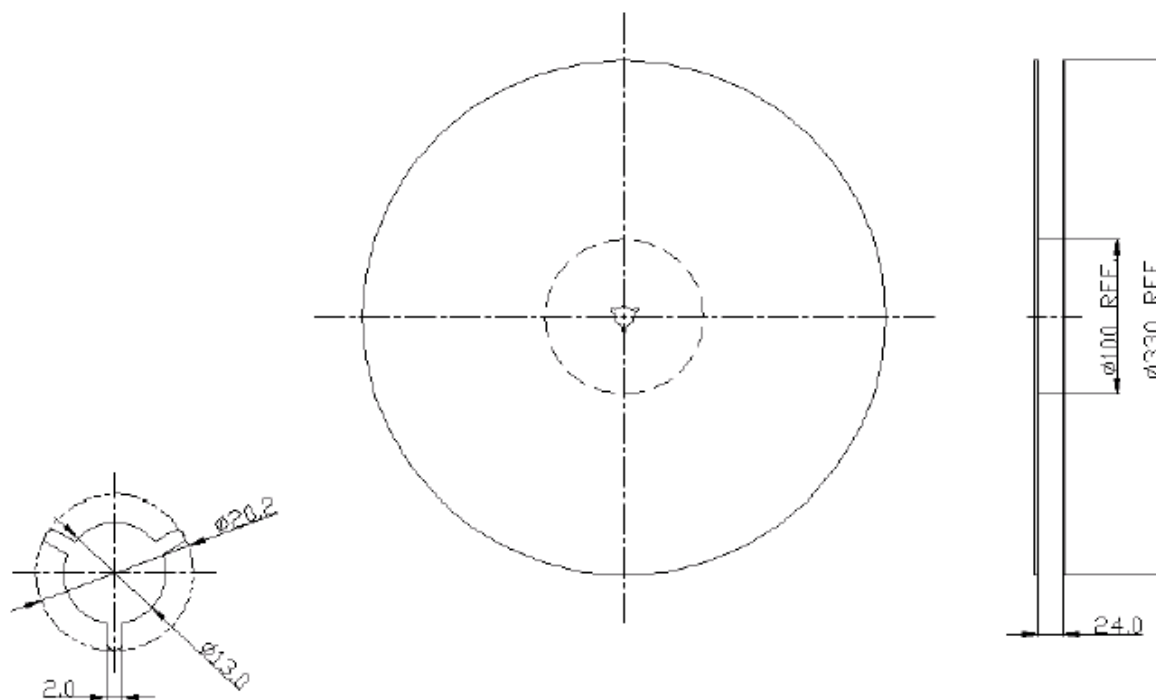
△ : Product / Year Code

PCB Pad Layout

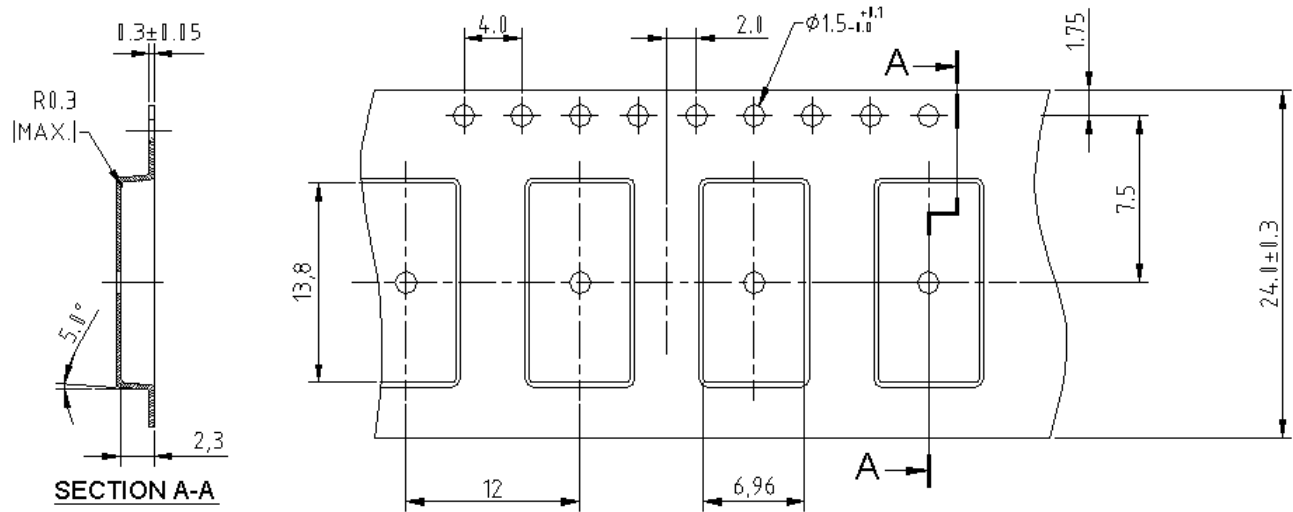


Tape and Reel Specifications

Reel Count:
7" = 500
13" = 1000



13.3X6.5



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180°C for 60~90 seconds.
2. Ascending time to preheating temperature 150°C shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C +0/-5°C peak (10 seconds).
4. Time: 5 times maximum.

